

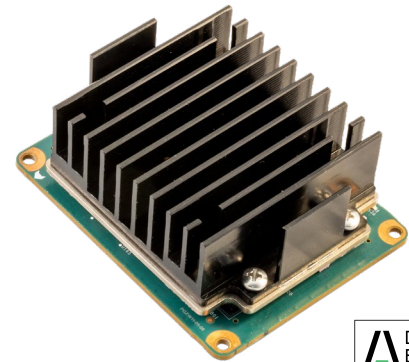
The Avnet heat sink for Kria K26 is designed specifically for the AMD-Xilinx Kria K26 system on module (SOM). The heat sink mounts directly to the heat spreader plate that comes standard on the K26 SOM. This solution is “turn key” as it includes the mounting hardware as well as the interface “gap” material preinstalled on the heat sink.

The Avnet heat sink for Kria K26 is designed to provide passive relief for designs up to 10W in room temperature (approximately 26C) applications. Designed with flexibility in mind, mounting holes in the heat sink allow for the addition of a standard 50x50mm fan. The addition of a fan provides maximum thermal relief capability allowing for higher power and higher ambient temperature operation. Power and environmental parameters should be considered when selecting your solution. Whether passive or active, the Avnet heat sink for Kria K26 has you covered!

Kit includes

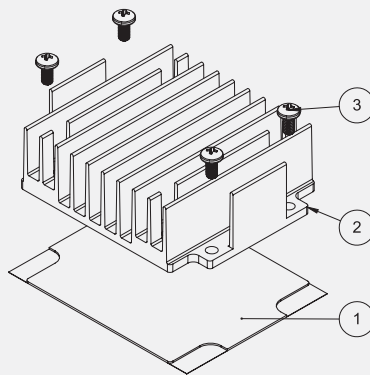
- Custom aluminum heat sink extrusion designed for the AMD-Xilinx Kria K26 SOM
- Preinstalled thermal gap material optimized for heat transfer
- 4 mounting screws

For more information visit: avnet.me/heat-sink-for-kria-k26



Target apps

- AMD-Xilinx Kria K26 System-On-Modules



Item #	Description	Qty.
1	TIM	1
2	HEATSINK	1
3	BHCS, M3 X 0.5, L=6	4

Parts

Part number	Description	Price and availability
AES-ACC-KRIA-HSINK	Avnet heat sink for AMD-Xilinx Kria K26 SOM	avnet.me/heat-sink-for-kria-k26-pdp

Countries available for purchase: Americas, EMEA, Asia, Japan

Contact information

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